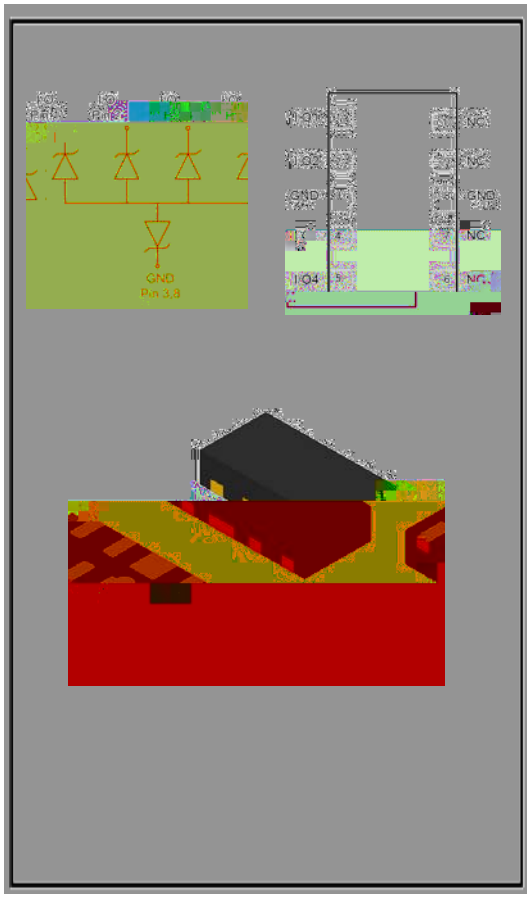

- Operating voltage: 24V
- Transient protection for each line according to
  IEC61000-4-2(ESD): ±30kV (contact)
  IEC61000-4-5(surge): 5A (8/20μs)
- Ultra low capacitance: Cj=6pF typ
- Ultra low leakage
- Low clamping voltage
- Up to 4 lines protects
- RoHS Compliant● Terminals: Tin plated leads, solderabl per J-STD-002 and JESD22-B102
- Moisture Sensitivity: Level 3 per J-STD-020
- Marking Information: See Below

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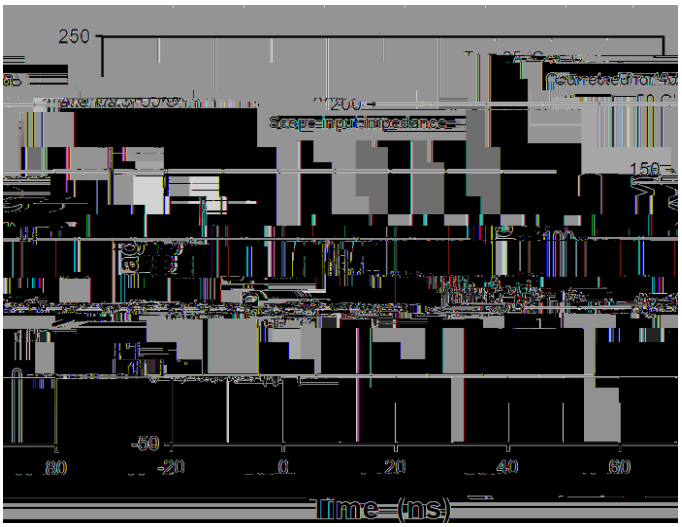
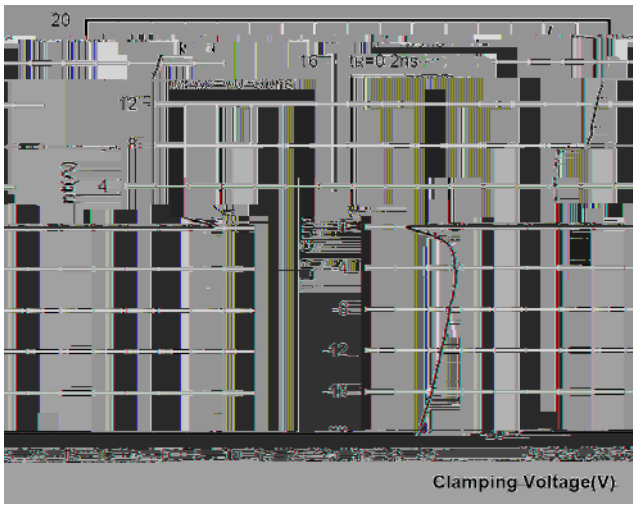
Peak pulse power (t_p = 8/20μs)	P_{pk}	170	W
Peak pulse current (t_p = 8/20μs)	I_{PP}	5	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	±30	KV
ESD according to IEC61000-4-2 contact discharge		±30	
Junction temperature	T_J	-55~125	°C
Storage temperature	T_{STG}	-55~150	°C

■ T_a=25 Unless otherwise specified

Reverse maximum working voltage	V_{RWM}	V	Any I/O pin to ground			24
Reverse leakage current	I_R	μA	V_{RWM} = 5.0V, any I/O pin to ground			0.2
Reverse breakdown voltage U	V_{BR}	V	I_T = 1mA, any I/O pin to groundR / ~ oa age			





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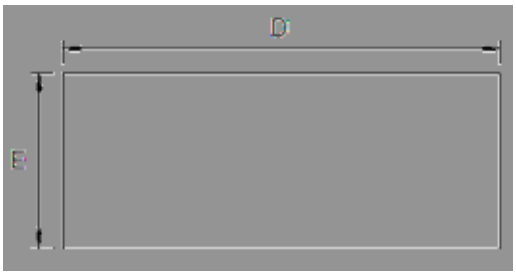
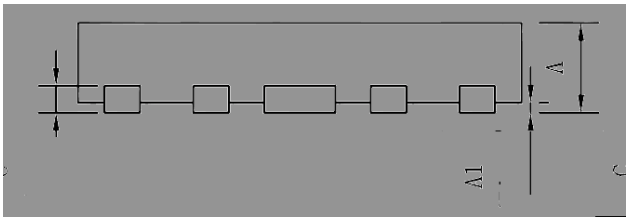
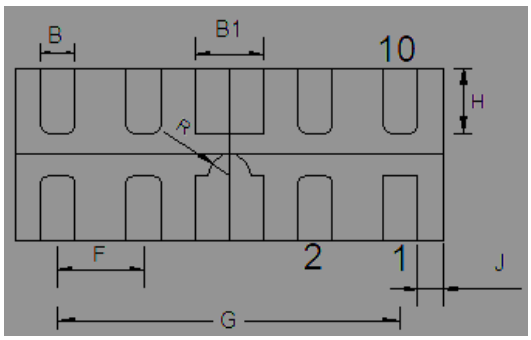
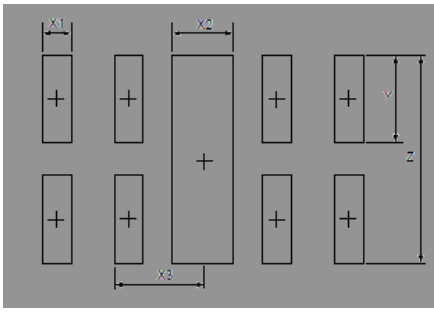






SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.40	0.45	0.50
A1	--	0.02	0.05
B	0.15	0.20	0.25
[illegible]	[illegible]	[illegible]	[illegible]
[illegible]	[illegible]	0.15	0.20
[illegible]	[illegible]	[illegible]	[illegible]



SYM	DIMENSIONS	
	MILLIMETERS	INCHES
X1	0.200	0.008
X2	0.400	0.016
X3	0.600	0.024
Y	0.600	0.024
Z	1.400	0.056

Notes:
This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.